## DATA SHEET



# BIPOLAR ANALOG INTEGRATED CIRCUIT $\mu$ PC1943,1944

## ADJUSTABLE PRECISION SHUNT REGULATORS

## **DESCRIPTION**

The  $\mu$  PC1943,1944 are adjustable precision shunt regulators with guaranteed thermal stability. The output voltage can be set to any value between reference voltage (1.26 V) and 24 V by two external resistors.

These ICs can apply to error amplifier of switching regulators.

## **FEATURES**

• Low voltage operation and High accuracy. VREF = 1.26 V  $\pm$  2.4 %

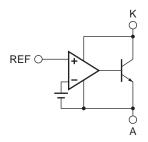
Adjustable output voltage by two external resistors.
 VREF ≤ VOUT ≤ 24 V

• Pin compatible to  $\mu$  PC1093.

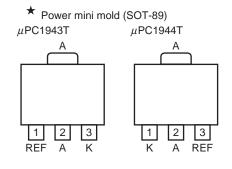
## ORDERING INFORMATION

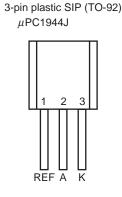
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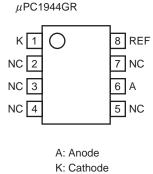
_	Part Number	Раскаде
* -	μPC1943T	Power mini mold (SOT-89)
*	$\mu$ PC1944T	Power mini mold (SOT-89)
	$\mu$ PC1944J	3-pin plastic SIP (TO-92)
	$\mu$ PC1944GR	8-pin plastic SOP (5.72 mm (225))



## PIN CONFIGURATION (Marking Side)







3-pin plastic SOP (5.72 mm (225))

REF: Reference
NC: No Connection

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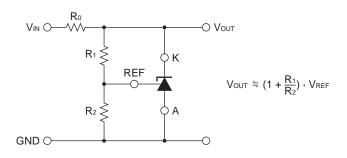
## ABSOLUTE MAXIMUM RATINGS (TA = +25 °C, unless otherwise specified.)

Parameter		Symbol	Ratings	Unit
Cathode Voltage		VKA	25	V
Cathode Current		lκ	50	mA
Cathode to Anode Reverse	Current	− <b>I</b> κ	-30	mA
Reference Voltage		VREF	7	V
Reference Input Current		IREF	50	μΑ
Reference to Anode Reverse Current		- IREF	<b>- 10</b>	mA
Total Power Dissipation	μPC1943T	Рт	320 (1600 <sup>Note</sup> )	mW
	μPC1944T		320 (1600 <sup>Note</sup> )	mW
	μPC1944J	]	560	mW
	μPC1944GR		385	mW
Operating Ambient Temperature		TA	- 30 to + 85	°C
Operating Junction Temperature		TJ	- 30 to + 125	°C
Storage Temperature		T <sub>stg</sub>	- 65 to + 125	°C

**Note** with  $16 \text{ cm}^2 \times 0.7 \text{ mm}$  ceramic substrate.

Caution Product quality may suffer if the absolute maximum rating is exceeded even momentarily for any parameter. That is the absolute maximum ratings are rated values at which the product is on the verge of suffering physical damage, and therefore the product must be used under conditions that ensure that the absolute maximum ratings are not exceeded.

## TYPICAL CONNECTION



## **RECOMMENDED OPERATING CONDITIONS**

Parameter		Symbol	MIN.	TYP.	MAX.	Unit
Cathode Voltage		VKA	Vref		24	V
Cathode Current		lκ	1	10	30	mA
Total Power Dissipation	μPC1943T	Р⊤			45 (240 <sup>Note</sup> )	mW
	μPC1944T				45 (240 <sup>Note</sup> )	mW
	μPC1944J				83	mW
	μPC1944GR				57	mW
Operating Ambient Temperature		TA	-30		+85	°C
Operating Junction Temperature		TJ	-30		+100	°C

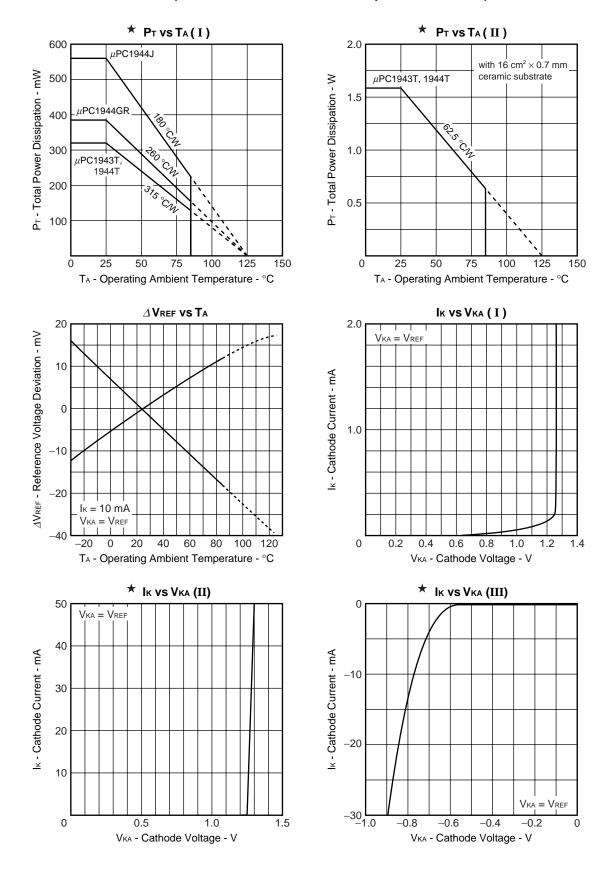
**Note** with  $16 \text{ cm}^2 \times 0.7 \text{ mm}$  ceramic substrate.

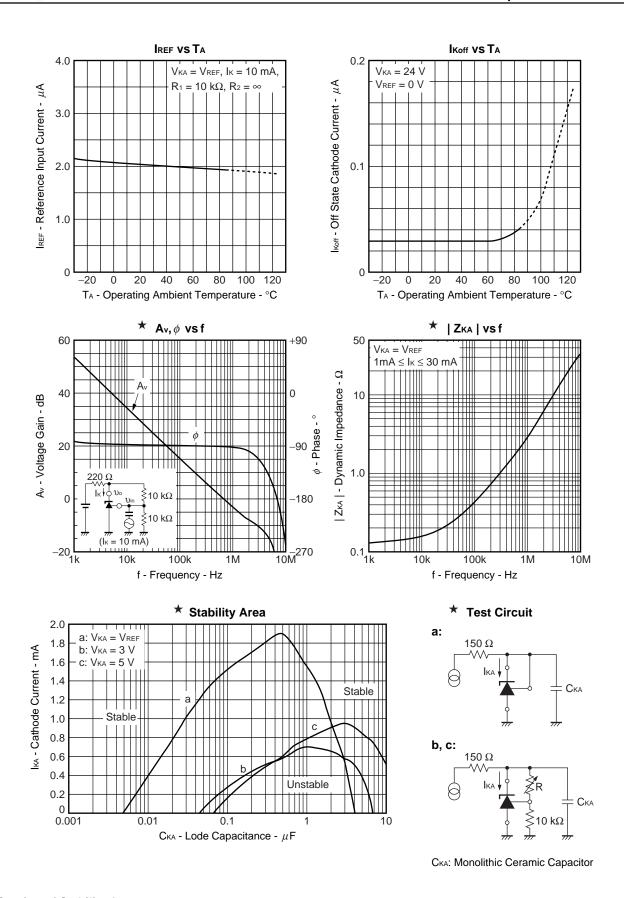
Caution The recommended operating range may be exceeded without causing any problems provided that the absolute maximum ratings are not exceeded. However, if the device is operated in a way that exceeds the recommended operating conditions, the margin between the actual conditions of use and the absolute maximum ratings is small, and therefore thorough evaluation is necessary. The recommended operating conditions do not imply that the device can be used with all values at their maximum values.

## ELECTRICAL CHARACTERISTICS ( $I\kappa = 10 \text{ mA}$ , $T_A = +25 \text{ °C}$ , unless otherwise specified.)

Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Reference Voltage	VREF	VKA = VREF	1.23	1.26	1.29	V
Reference Voltage Deviation Over Temperature	$\Delta V_REF$	VKA = VREF, 0 °C ≤ TA ≤ 70 °C		±5	± 30	mV
Reference Voltage Deviation	$\Delta  Vref / \! \Delta  Vka$	VREF   ≤ VKA ≤ 5V			2.7	mV/V
Over Cathode Voltage		5 V ≤ VKA ≤ 24V			2.0	mV/V
Reference Input Current	IREF	VKA = VREF, R <sub>1</sub> = 10 k $\Omega$ , R <sub>2</sub> = $\infty$		2.0	4.0	μΑ
Reference Input Current Deviation Over Temperature	$\Delta$ lref	$V_{KA} = V_{REF}, \ 0 \ ^{\circ}C \le T_{A} \le 70 \ ^{\circ}C,$ $R_{1} = 10 \ k\Omega, \ R_{2} = \infty$		0.3	1.2	μΑ
Minimum Cathode Current	Kmin	VKA = VREF, $\Delta$ VREF = 2 %		0.16	1.0	mA
Off-state Cathode Current	Koff	VKA = 24 V, VREF = 0 V		0.01	1.0	μΑ
Dynamic Impedance	ZKA	$V_{KA} = V_{REF}, f \le 1 \text{ kHz},$ $1 \text{ mA} \le I_K \le 30 \text{ mA}$		0.12	0.5	Ω

## TYPICAL CHARACTERISTIC (TA = +25 °C, unless otherwise specified. Nominal)



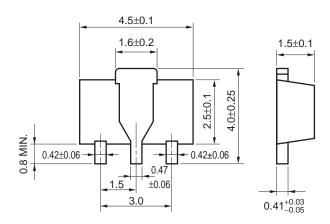


## ★ Caution of Stability Area

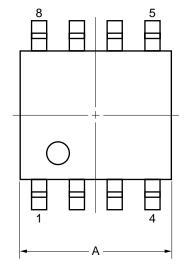
If the Aluminum electrolytic capacitor is used, it should be kept  $C_{KA} \ge 6.8 \ \mu F$ . When using plural different types of capacitors, each capacitor is needed to be stable independently.

## PACKAGE DRAWINGS

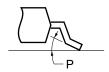
## **★** POWER MINI MOLD (SOT-89) (Unit: mm)

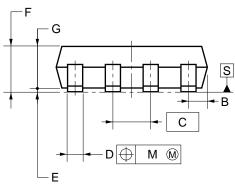


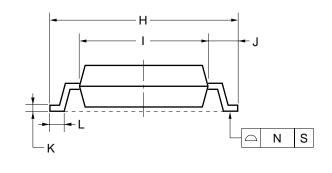
# 8-PIN PLASTIC SOP (5.72 mm (225))



detail of lead end







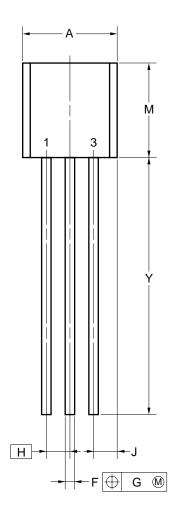
## NOTE

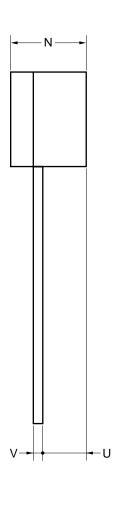
Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	$5.2 \begin{array}{l} +0.17 \\ -0.20 \end{array}$
В	0.78 MAX.
С	1.27 (T.P.)
D	$0.42^{+0.08}_{-0.07}$
Е	0.1±0.1
F	1.59±0.21
G	1.49
Н	6.5±0.3
I	4.4±0.15
J	1.1±0.2
К	$0.17^{+0.08}_{-0.07}$
L	0.6±0.2
М	0.12
N	0.10
Р	3°+7°
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S8GM-50-225B-6

## 3-PIN PLASTIC SIP (TO-92)





## NOTE

Each lead centerline is located within 0.12 mm of its true position (T.P.) at maximum material condition.

ITEM	MILLIMETERS
Α	5.0±0.2
F	$0.50^{+0.30}_{-0.10}$
G	0.12
Н	1.27
J	1.33 MAX.
М	5.0±0.5
N	4.0±0.2
U	2.8 MAX.
V	0.50±0.10
Υ	15.0±0.7

P3J-127B-3

## RECOMMENDED SOLDERING CONDITIONS

When soldering these products, there are highly recommended to observe the conditions as shown below.

If other soldering processes are used, or if the soldering is performed under different conditions, please make sure to consult with our sales offices.

For more details, refer to our document "Semiconductor Device Mounting Technology Manual" (C10535E).

## **Type of Surface Mount Device**

## $\star$ $\mu$ PC1943T, 1944T : Power mini mold (SOT-89)

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235 °C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210 °C or higher), Maximum number of reflow processes: 2 times.	IR35-00-2
VPS	Peak temperature: 215 °C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200 °C or higher), Maximum number of reflow processes: 2 times.	VP15-00-2
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120 °C or below (Package surface temperature).	WS60-00-1

Caution Apply only one kind of soldering condition to a device, or the device will be damaged by heat stress.

## $\mu$ PC1944GR : 8-pin plastic SOP (5.72 mm (225))

Process	Conditions	Symbol
Infrared ray reflow	Peak temperature: 235 °C or below (Package surface temperature), Reflow time: 30 seconds or less (at 210 °C or higher), Maximum number of reflow processes: 1 time.	IR35-00-1
VPS	Peak temperature: 215 °C or below (Package surface temperature), Reflow time: 40 seconds or less (at 200 °C or higher), Maximum number of reflow processes: 1 time.	VP15-00-1
Wave soldering	Solder temperature: 260 °C or below, Flow time: 10 seconds or less, Maximum number of flow processes: 1 time, Pre-heating temperature: 120 °C or below (Package surface temperature).	WS60-00-1

Caution Apply only one kind of soldering condition to a device, or the device will be damaged by heat stress.

## Type of Through-hole Device

## $\mu$ PC1944J : 3-pin plastic SIP (TO-92)

Process	Conditions
Wave soldering (only to leads)	Solder temperature: 260 °C or below, Flow time: 10 seconds or less.

Caution For through-hole device, the wave soldering process must be applied only to leads, and make sure that the package body does not get jet soldered.

## \* REMARK OF THE PACKAGE MARK

The package marks of the  $\mu\text{PC1943T}$  and the  $\mu\text{PC1944T}$  are the symbols as follows.

Part Number	Mark
μPC1943T	9B
μPC1944T	9C

## REFERENCE DOCUMENTS

Semiconductor Device Mounting Technology Manual C10535E Semiconductor Selection Guide -Products and Packages- X13769X **NEC**  $\mu$  PC1943,1944

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  - Specific: Aircraft, aerospace equipment, submersible repeaters, nuclear reactor control systems, life support systems or medical equipment for life support, etc.

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